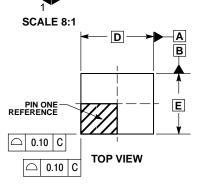
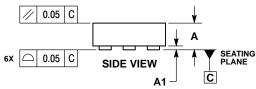
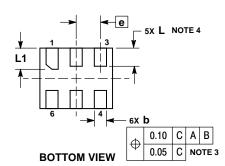
ULLGA6, 1.2x1.0, 0.4P CASE 613AE ï01 **ISSUE A**

DATE 06 FEB 2008





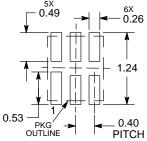


NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED TERMINAL
 AND IS MEASURED BETWEEN 0.15 AND
 0.30 mm FROM THE TERMINAL TIP.
 A MAXIMUM OF 0.05 PULL BACK OF THE
 PLATED TERMINAL FROM THE EDGE OF THE
 PLATED TERMINAL FROM THE EDGE OF THE
 PLACE OF ALL OWER.
- PACKAGE IS ALLOWED.

	MILLIMETERS		
DIM	MIN	MAX	
Α	ΪΪΪ	0.40	
A1	0.00	0.05	
b	0.15	0.25	
D	1.20 BSC		
E	1.00 BSC		
е	0.40 BSC		
L	0.25	0.35	
L1	0.35	0.45	

MOUNTING FOOTPRINT SOLDERMASK DEFINED*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb ïFree strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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